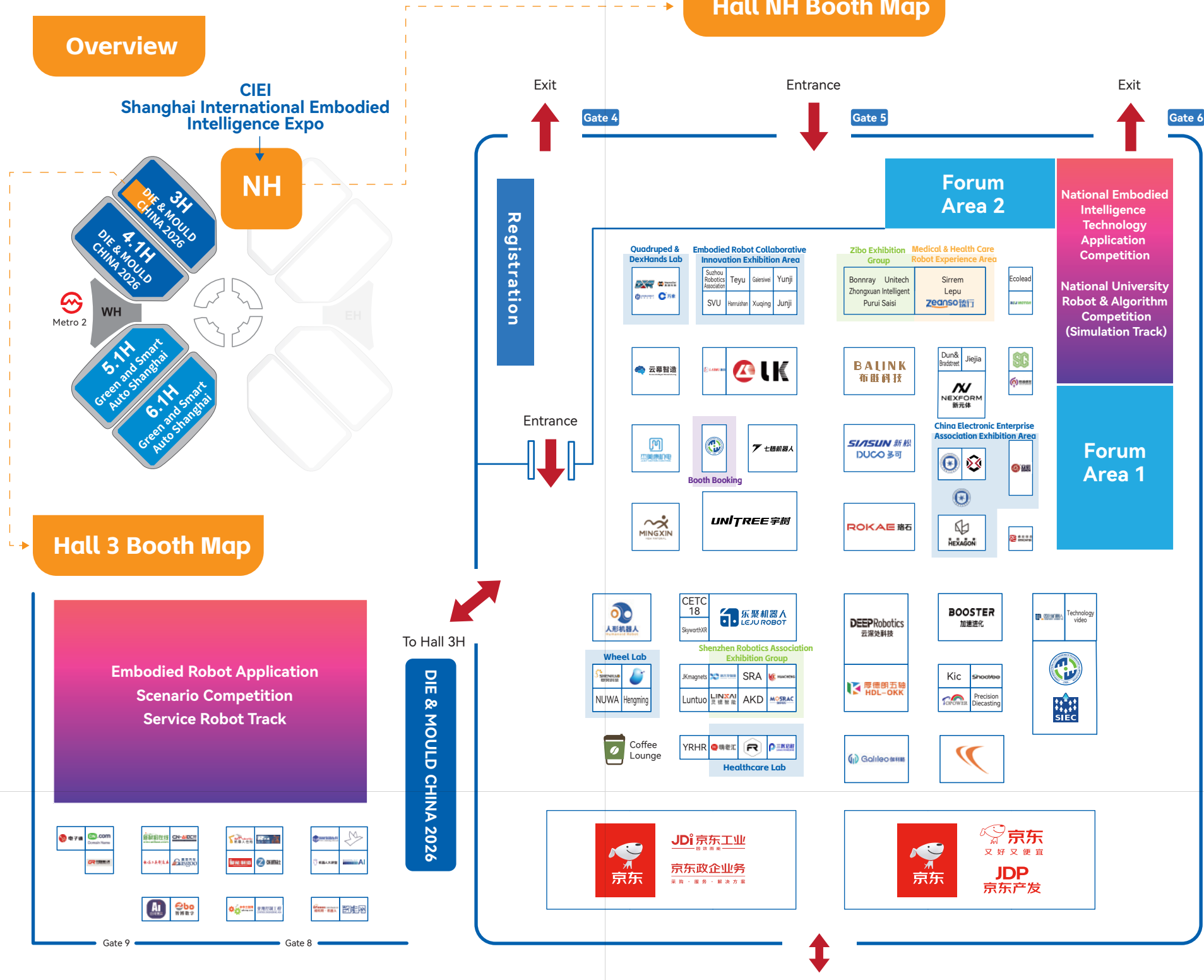


Exhibition Booth Map



Exhibitors

Aikedi Industrial Robot (Shenzhen) Co., Ltd.
Bonnray (Shandong) Robot Co., Ltd.
Beijing Bulian Technology Co., Ltd.
Booster Robotics
Beijing Research Institute of Precision Mechatronics and Control Equipment
Beijing Inspire-Robots Technology Co., Ltd.
Beijing Yunji Technology Co., Ltd.
Changzhou Feiyu Robot Technology Co., Ltd.
Changzhou Songjie Motor & Electric Appliance Co., Ltd.
Dimenshen (Shanghai) Technology Co., Ltd.
Fuhefu (Shanghai) Enterprise Management Co., Ltd.
Guangdong LINXAI Intelligent Technology Co., LTD.
Jiejia Zhizao Technology (Suzhou) Co., Ltd.
Hexagon Manufacturing Intelligence (Qingdao) Co., Ltd.
Hangzhou Heiman Technology Co., Ltd.
Hangzhou Jingrui Jiuyan Technology Co., Ltd.
Hangzhou Shenhao Technology Co., Ltd.
Hangzhou Yudao AI Technology Co., Ltd.
Hangzhou Yunshenchu Technology Co., Ltd.
Houderland Equipment (Suzhou) Co., Ltd.
Jilin Shuyi Medical Technology Co., Ltd.
Galileo (Tianjin) Technology Co., Ltd.
Jiangsu Jinzhi Datong Power Technology Co., Ltd.
Jiangsu Topower Tyre Co., Ltd.

Jiangsu Yunmu Zhizao Technology Co., Ltd.
JD Embodied Intelligence Industry Ecosystem Pavilion
Lejoin Intelligence (ShenZhen) Co., Ltd.
L.K. Precision Machinery (Kunshan) Co., Ltd.
Lingtong Robot (Shanghai) Co., Ltd.
Luming Robotics Technology (Shenzhen) Co., Ltd.
ROKAE (Shandong) Robot Group Co., Ltd.
Mingxin Zhiyuan (Zhejiang) New Material Technology Co., Ltd.
Magic Atomic Robotics Technology (Wuxi) Co., Ltd.
Ningbo JK Magnets Co., Ltd.
Nüwa Agricultural Technology (Shenzhen) Co., Ltd.
Sevnce Robotics Co., Ltd.
Humanoid Robot (Shanghai) Co., Ltd.
Sanhui Qicheng (Shanghai) AI Technology Co., Ltd.
Shandong Zhongxuan Intelligent Technology Co., Ltd.
Shanghai Dajie Robot Technology Co., Ltd.
Shanghai Daxiang Zhangliang Nano Technology Co., Ltd.
Shanghai University
Shanghai Dun & Bradstreet Business Information Consulting Co., Ltd.
Shanghai Dongyan Machinery Parts Co., Ltd.
SHANGHAI-FANUC ROBOTICS CO., LTD.
Shanghai Hengming Law Firm
Shanghai Karlang Industrial Co., Ltd.

Shanghai Laimu Electronics Co., Ltd.
Shanghai Lintel Network Technology Co., Ltd.
Shanghai Artificial Intelligence Research Institute Co., Ltd.
Shanghai Electronic Circuit Industry Association
Shanghai Shiduo Intelligent Technology Co., Ltd.
Shanghai Traffic Electronics Industry Association
Shanghai Communication Manufacturing Industry Association
Shanghai Sirrem Medical Technology Co., Ltd.
Shanghai YORP Electric Manufacturing Co., Ltd.
Shanghai Zhongchen Electronic Technology Co., Ltd.
Shenzhen Skyworth New World Technology Co., Ltd.
Shenzhen Huaqiang Semiconductor Group Co., Ltd. / NeuSemi Group Co., Ltd.
Shenzhen Lepu Cloud Intelligence Technology Co., Ltd.
Shenzhen Huacheng Industrial Control Co., Ltd.
Shenzhen Robotics Association
Shenzhen Just Motion Control Electromechanics Co., Ltd.
China Leadshine Technology Co., Ltd.
Shenzhen XJCSENSOR Technology Co., Ltd.
Shenzhen Mosrac Motor Co., Ltd.
Shenzhen New Dahua Intelligent Technology Co., Ltd.
Sihui Fuji Electronics Technology Co., Ltd.
Suzhou Galsewell Intelligent Technology Co., Ltd.
Suzhou Junji Robot Technology Co., Ltd.

Suzhou Xuqing Intelligent Technology Co., Ltd.
Suzhou Teyu Robot Technology Co., Ltd.
Suzhou Hanruishan Technology Co., Ltd.
Suzhou Vocational and Technical University
Suzhou Robotics Industry Association
Wanna Robot (Beijing) Co., Ltd.
Wuhan Shengshi Qichuang Technology Co., Ltd.
Wutong Gankong (Beijing) Technology Co., Ltd.
Xi'an Ruikong Chuanghe Electronic Technology Co., Ltd.
Xi'an Jiaotong-Liverpool University
Yongying Financial Leasing Co., Ltd.
Youligji Robot Technology (Suzhou) Co., Ltd.
Younaide (Shandong) Motor Technology Co., Ltd.
Unitree Technology Co., Ltd.
Yunrui Technology (Shanghai) Co., Ltd.
Zhejiang Hehui Robot Technology Co., Ltd.
Zhejiang Youkeli New Material Co., Ltd.
Zhejiang Zhengxing Technology Co., Ltd.
China Electronic Enterprise Association
China Electronic Enterprise Association Industrial Embodied Intelligence Branch
China Electronic Enterprise Association Talent Exchange Branch
Zhongke Xinsong Co., Ltd.
Zibo Puruisesi Machinery Equipment Co., Ltd.

Note: Listed in no particular order.

Concurrent Events



Forum & Conference

- July 2** 09:30-12:10 2026 Embodied Intelligence Industry Ecosystem Conference (Opening Ceremony + Main Forum)
13:30-17:00 Scenario Application of Embodied Intelligence
- July 3** 09:30-12:20 Innovation of Key Components for Embodied Intelligence
13:30-16:40 Standard System Construction and Collaborative Development of Embodied Intelligence
- July 4** 09:30-12:10 Industry-Education Integration and Talent Cultivation for Embodied Intelligence



Overseas Matchmaking

- July 3** 14:00-17:00 2026 Global Embodied Intelligence Industrial Chain Overseas Cooperation Matchmaking Event



Industry Exchange Events

- July 2** 13:30-15:30 CIEI 2026 "Embodied Intelligence, Empowered Future" — Yangtze River Delta Venture Capital Roadshow — Embodied Intelligence Special Session
- July 3** 10:00-11:30 RobotCrew Salon — Embodied Intelligence Data Collection Special Session
- July 4** 10:00-11:30 RobotCrew Salon — Embodied Scenario Implementation & Business Model Special Session



Competition

National Embodied Intelligence Technology Application Competition

- July 1** 09:00-17:30 2026 National Embodied Intelligence Technology Application Competition (Setup and Testing)
- July 2** 09:00-17:30 2026 National Embodied Intelligence Technology Application Competition
- July 3** 09:00-17:30 2026 National Embodied Intelligence Technology Application Competition

Embodied Robot Application Scenario Competition Service Robot Track

- July 2** 09:00-17:30 2026 Embodied Robot Application Scenario Competition —Service Robot Track (Setup and Testing)
- July 3** 09:00-17:30 2026 Embodied Robot Application Scenario Competition —Service Robot Track
- July 4** 09:00-12:00 Award Ceremony of 2026 Embodied Robot Application Scenario Competition

National University Robot & Algorithm Competition (Simulation Track)

- July 3** 13:00-17:30 National University Robot & Algorithm Competition — Simulation Track



Embodied Intelligence Empowered Future

Shanghai International Embodied Intelligence Expo 2026

Visitor Guide

July 2-4, 2026

National Exhibition and Convention Center (Shanghai)

Hosts:

China Association for Mechatronics Technology and Application (CAMETA)
Shanghai International Exhibition (Group) Co., Ltd.

Co-organizers:

Embodied Intelligence Society of CAMETA
Intelligent Robots Society of CAMETA
Intelligence and Robotics Education Society of CAMETA

Medical and Health Care Robots Society of CAMETA
Education and Training Committee of CAMETA

Supporters:

Shanghai Die Casting Technology Association
Beijing Robot Industry Association
Zhejiang Robot Industry Association
Suzhou Robot Industry Association
Wuxi Robot & Intelligent Manufacturing Association
Wuxi Association of Engineers
Shenzhen Robotics Association
Shandong Robotics Industry Association

Shandong Robotics Society
Qingdao Robot Society
Hangzhou Association For Artificial Intelligence
Tianjin Robot Industry Association
Changzhou Industrial Robotics Industry Association
Chongqing Robot Industry Alliance
China Council for the Promotion of International Trade Wuxi Sub-council

Overseas-Supporters:

Humanoid Robotics Association Switzerland (HRAS)
Italy Belt and Road Institute

Thai Automation & Robotics Association
Cameroon Robotics Association



Shanghai International Embodied Intelligence Expo 2027

Embodied Intelligence Pavilion of the Shanghai International Automobile Industry Exhibition.
July 2-4, 2026 | National Exhibition and Convention Center (Shanghai)

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Shanghai International Exhibition (Group) Co., Ltd.
Shanghai International Exhibition Management Co., Ltd.

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E-mail: ciei@siec-ccpit.com

(86)-139 1640 0225
Web: www.siec-ccpit.com

2026 Embodied Intelligence Industry Ecosystem Conference

09:30 – 12:10, July 2		Forum Area 1, Hall NH, NECC(Shanghai)
Opening Ceremony		
Host: Wang Jihong Executive Vice President,CAMETA; Senior Professor-level Engineer		
09:30-10:00		
1. Address by Qu Daokui, President of CAMETA		
2. Address by Gu Chunting, Vice President of Shanghai CCPIT		
3. Address by Distinguished Guests		
4. CIEI Expert Appointment and Certificate Presentation Ceremony		
5. Launch Ceremony		
Official Release		
10:00-10:30		
1. Release of group standards for embodied intelligence		
2. Joint release of innovative technologies and products		
3. Release of China Embodied Intelligence Industry Development Report (2026)		
Keynote Speeches		
Host: Cheng Guang Vice President & Secretary-General, CAMETA; Professor		
10:30-10:55		
Intelligent Wave and Multi-dimensional Perception		
Chu Junhao		
Member of the Chinese Academy of Sciences, Researcher, Shanghai Institute of Technical Physics, CAS, Dean & Professor, Optoelectronics Research Institute, Fudan University		
10:55-11:20		
Development Status and Trends of Embodied Intelligent Robots		
Qu Daokui		
President & Researcher of CAMETA		
11:20-11:45		
Perception Technologies for Embodied Intelligent Robots		
Sun Lining		
Foreign Member of the Russian Academy of Engineering; Chief Scientist & Professor, Suzhou Provincial Key Laboratory of Embodied Intelligent Robots, Jiangsu University		
11:45-12:10		
Building the Mental World Model for Intelligent Robots — A New Paradigm of Embodied Intelligence		
Huang Dongyan		
Chief Scientist, Shenzhen Zhituo Xinyang Technology Co., Ltd.		

Forum on Innovation of Key Components for Embodied Intelligence

09:30 – 12:20, July 3		Forum Area 1, Hall NH, NECC(Shanghai)
Opening Address		
Host: Ming Cuixin Deputy Secretary-General, CAMETA		
09:30-09:40		
1. Guest Introduction		
2. Address by leaders of CAMETA		
Keynote Speeches		
09:40-10:10		
Interaction-Driven Embodied Intelligence for Breaking the Efficiency Bottleneck of Flexible Assembly		
Chen Wenjie		
Professor and Doctoral Supervisor at Anhui University, IEEE Senior Member, Executive Deputy Director of Anhui Provincial Engineering Laboratory of Human Machine Integrated Systems and Intelligent Equipment		
10:10-10:40		
Model Learning-Driven Embodied Intelligence and Practice		
Zeng Limin		
Associate Professor at Zhejiang University, Member of the CCF Technical Committee on Human Computer Interaction		
10:40-11:00		
Core Components Fuel the Prosperity of Embodied Intelligence		
Feng Wenhai		
Vice President, Shanghai Zhongchen Electronics Technology Co., Ltd.		
11:00-11:20		
Cutting-edge Application and Development of New Chain Drive Technology in Embodied Intelligence		
Xu Yonglei		
General Manager, Shanghai Zhenghe Robot Co., Ltd.		
11:20-11:40		
One-stop Force Control System Solution for Embodied Intelligent Robots		
Wu Hao		
Chairman, Shenzhen Xinjingcheng Sensing Technology Co., Ltd.		
11:40-12:00		
Electronic Skin Based on Integrated Functional Leather		
Luo Zheng		
Group Deputy General Manager, Mingxin Xuteng New Materials Co., Ltd.		
12:00-12:20		
Pain Points in Scenario Implementation and Component Opportunities for Humanoid Robots		
Fu Mengzhen		
Head of Embodied Intelligent Robot Business & Chief Analyst, Ruigongye		

Forum on Standard System Construction and Collaborative Development of Embodied Intelligence

13:30 – 16:40, July 3		Forum Area 1, Hall NH, NECC(Shanghai)
Opening Address		
Host: Liu Minglei Deputy Secretary-General, CAMETA		
13:30-13:40		
1. Introduction of forum background and guests		
2. Address by leaders of CAMETA		
Keynote Speeches		
13:40-14:10		
Introduction to Industrial Development and Standardization of Embodied Intelligence Technologies		
Wang Yuntao		
Deputy Chief Engineer & Senior Professor-level Engineer, Institute of Artificial Intelligence, China Academy of Information and Communications Technology		
14:10-14:40		
From Demonstrable to Usable to Reliable: Establishing an Evaluation System for Embodied Intelligence		
Lian Wenzhao		
Professor, School of Artificial Intelligence, Shanghai Jiao Tong University, Founder, Yuanlu Technology		
14:40-15:10		
From Standard System to Scenario Implementation: How Embodied Intelligence Testing Technologies Pave the Way for Large-scale Application		
Zheng Junqi		
President, Shanghai Robotics Industry Technology Research Institute, Director, National Robot Testing and Evaluation Center (Headquarters)		
15:10-15:40		
Current Status and Key Standards of Robot Standardization		
Yang Shuping		
Researcher, Robot Branch, China Machinery Industry Federation		
15:40-16:10		
Empowering Technological Innovation and Competitive Edge of Embodied Intelligent Robots via Standardization		
Qu Weixin		
Vice President & Secretary-General, Suzhou Robot Association		

Forum on Industry-Education Integration and Talent Cultivation for Embodied Intelligence

09:30 – 12:10, July 4		Forum Area 1, Hall NH, NECC(Shanghai)
Opening Address & Award Ceremony		
Host: Hu Shanshan Director, Industry-Education Integration Office, CAMETA		
09:30-09:50		
1. The host introduces the background, objectives and guests of the forum		
2. Address by leaders of CAMETA		
3. Award Ceremony for the National Finals of the 2025 National University Robot and Algorithm Competition — Simulation Track		
Keynote Speeches		
09:50-10:20		
Practices and Exploration on Embodied Intelligent Robot Technology and Talent Cultivation		
Deng Sanpeng		
Professor & Doctoral Supervisor, Tianjin University of Technology and Education, Director, Tianjin Key Enterprise Laboratory of Intelligent Robot Technology and Application		
10:20-10:50		
Building a New Innovation Talent Training Model for Embodied Intelligence through Industry-Education Integration		
Chen Wei		
Dean & Professor, Tianyihu College of Innovation, Nanjing Institute of Technology		
10:50-11:05		
Intelligent Scenario Application of Tencent Cloud Workbuddy		
Zhang Xiangyue		
Tencent Cloud		
11:05-11:20		
Restructuring the Industry-Driven Training Paradigm for Embodied Intelligence Talents		
Wang Aizhu		
Senior Project Director, Galaxy General Education Division		
11:20-11:35		
Huibo's Talent Cultivation Program for Embodied Intelligence via Industry-Education Integration		
Xu Hui		
R&D Director & PhD, Jiangsu Huibo Robot Technology Co., Ltd.		
11:35-11:55		
Research on the Discipline Construction Plan for Embodied Intelligence		
Ren Lifeng		
Co-founder, Global Salle (Beijing) Technology Co., Ltd.		
11:55-12:10		
Thoughts on the Embodied Intelligence Trend and Zhiyuan's Industry-Education Integration		
Wei Chang		
Director of Scientific Research and Education Department, Zhiyuan Innovation (Shanghai) Technology Co., Ltd.		
13:00-17:00		
Visit to Agibot		

RoboCrew Salon

July 3, 2026 10:00 – 11:30		Forum Area 2, Hall NH, NECC(Shanghai)
Roundtable Discussion: Embodied Intelligence Data Acquisition Session		
Host: Liu Qidi Founder of RoboCrew		
Guests		
Kang Qiansong	CEO, Shanghai Souta Technology Co., Ltd.	
Wang Shu	CMO, Beijing Lingyu Intelligent Technology Co., Ltd.	
Ji Yaohui	CTO, Codec (Hangzhou) Robotics Technology Co., Ltd.	
Wang Baitang	CMO, Dahuan Robotics Technology Co., Ltd.	
July 4, 2026 10:00 – 11:30		Forum Area 2, Hall NH, NECC(Shanghai)
Roundtable Discussion: Embodied Scenario Implementation and Business Models Session		
Host: Liu Qidi Founder of RoboCrew		
Guests		
Niu Guohua	Deputy General Manager, Dimanshen (Shanghai) Technology Co., Ltd.	
Wei Chang	Director of Research & Education, Zhiyuan Innovation (Shanghai) Technology Co., Ltd.	
Xiao Rongwei	CEO, Shanghai Yibibote Intelligent Technology Co., Ltd. (EasyBot Robot)	
Wang Xiaofeng	General Manager, Robot Cluster BU, Shanghai Mankun Computer Technology Co., Ltd.	

2026 Global Embodied Intelligence Industrial Chain Overseas Cooperation Matchmaking Event Agenda

14:00-17:30, July 3		Forum Area 2, Hall NH, NECC(Shanghai)
Keynote Speeches		
Host: Chen Kun Assistant President, Shanghai International Exhibition (Group) Co., Ltd. Deputy General Manager, Shanghai International Exhibition Management Co., Ltd.		
14:00-14:15		
Opening Remarks		
Wang Deyang Deputy Director-General, Foreign Trade Development Affairs Bureau, Ministry of Commerce, PRC		
Qu Daokui President, China Mechatronics Technology Application Association		
Xu Jia President, Shanghai International Exhibition (Group) Co., Ltd.		
Policy Briefing for Embodied Intelligence Enterprises Going Global		
14:15-14:25		
From "Going Global" to "Rooting In": CCPIT Shanghai Empowers Enterprises on Their New Overseas Expansion Journey		
Di Rong Deputy Director, Trade and Investment Promotion Department, CCPIT Shanghai		
14:25-14:35		
The cross-border financial service system supports enterprises in going global		
Gong Jiantao General Manager, Cross-border Finance Dept. (Offshore Banking Center) Shanghai Pudong Development Bank Co., Ltd.		
14:35-14:45		
Empowering Enterprises Going Global with Quality Legal Services: From the Perspective of Commercial Arbitration		
Yang Guang Deputy Secretary-General, Shanghai International Arbitration Center		
14:45-14:55		
From Manufacturing Excellence to Global Trust: Data Empowers Embodied Intelligence Enterprises' Global Layout		
Zhang Mingjun Expert, Shanghai D&B Business Information Consulting Co., Ltd.		
Overseas Market & Scenario Release		
14:55-15:05		
Investment Opportunities in Pakistan		
Shehzad Ahmad Khan Consul General, Consulate General of Pakistan in Shanghai		
15:05-15:15		
Thailand 4.0 & Application Scenarios of Embodied Intelligence in Southeast Asian Markets		
Tawee Pawanakorn Director of International Affairs,Thai Automation & Robotics Association		
15:15-15:25		
From Automation to Embodied Intelligence: Global Cooperation & Scenario Implementation from the Chain Owner's Perspective		
Li Dong President & Vice President, Rockwell Automation Intelligent Manufacturing Innovation Research Institute		
15:25-15:35		
China-Africa Cooperation Boosts Development of Embodied Intelligence Industrial Chain		
Jacques Eone Founder & Chairman, Cameroon Robotics Association		
15:35-15:45		
HRAS Switzerland: Regulatory Compliance & Scenario Matching for Robots Entering		
Mr. Roberto D'Elia President, Swiss Humanoid Robotics Association; Chairman, World Humanoid Robot Championship		
15:45-16:00		
Demand Release		
Trade Matching Session		
16:00-17:30		
Matching Negotiations for Participating Enterprises		

CIEI 2026: "Embodied Intelligence, Empowered Future"--- Yangtze River Delta Entrepreneurship Roadshow — Embodied Intelligence Session

July 2, 2026 13:30 – 15:30		Forum Area 2, Hall NH, NECC(Shanghai)
Roadshow Process		
Host: Chenchen Shanghai Financial Host; Bilingual Guest Instructor for the "SS Diplomat" program on Shanghai Television.		
13:30-13:35		
Host Opening Remarks		
13:35-13:45		
Keynote: "2026 Embodied Intelligence Industry — Investment Window Driven by World Models"		
14:00-14:15		
Project 1: Shanghai Qingxinyichuang Technology Co., Ltd.		
14:15-14:30		
Project 2: Shanghai SLAM Technology Co., Ltd.		
14:30-14:45		
Project 3: Yiibo Intelligent Robotics (Shanghai) Co., Ltd.		
14:45-15:00		
Project 4: Dimanshen (Shanghai) Technology Co., Ltd.		
15:00-15:30		
Project 5: Shanghai Miji Technology Co., Ltd.		

Exhibiting Brands (Partial)

UNITREE宇树	乐惠机器人 LEJU ROBOT	ROKAE 瑞石	FANUC	HEXAGON
DEEPRobotics 云深达科技	SIASUN 新松 DUCO 多可	人形机器人	BOOSTER 加速进化	Galileo 伽利略
七趣机器人	四叶机器人	BALINK 布链科技	UK	MINGXIN
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蓝普纪元	CSEA	聚辰	XUCENSOR 鑫精成传感器	PROSITY
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PETA	恩慈智能	STEAD	XUTLU	
永赢金租	FSQuality	ASTOR TECH	大界	NeuSemi 神经网络芯片
SRA	新大华智能	DXR	NUWA	LEPU 乐普
SIRREM 赛列姆	黑漂科技	HaymoDex	万拿	R
HUACHENG	zednso 臻行	SHENLAB 申研科技	SOJ MOTOR	UNISBOT
LINXAI 灵锡智能	三昇程程	嗨老汇	上海浦东智能装备有限公司	京东
京东政企业务	JDI 京东工业	京东 文财文财	JDP 京东产发	云迹科技

Note: Listed in no particular order.

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